

**N-Ch MOSFET** 

## **General Description**

The WSF28N06 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF28N06 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

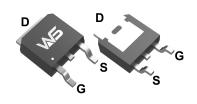
### **Product Summery**

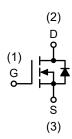
BVDSS	RDSON	ID
60V	28mΩ	28A

### **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- LCD/LED back light

## **TO-252-2L Pin Configuration**





## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>A</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	28	А
I <sub>D</sub> @T <sub>A</sub> =70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	17	Α
I <sub>DP</sub>	Pulsed Drain Current <sup>2</sup>	96	Α
EAS	Single Pulse Avalanche Energy <sup>3</sup>	22	mJ
I <sub>AS</sub>	Avalanche Current	28	Α
P <b></b> _@T <sub>C</sub> =25°C	Total Power Dissipation⁴	60	W
P <sub>D</sub> @T <sub>c</sub> =100℃	Total Power Dissipation⁴	30	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 175	$^{\circ}$
$T_J$	Operating Junction Temperature Range	$^{\circ}\mathbb{C}$	

### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>		50	°C/W
R <sub>eJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		2.5	°C/W



## Electrical Characteristics ( $T_J=25$ °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_D$ =250uA	60			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25℃ , I <sub>D</sub> =1mA		0.057		V/°C
В	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =12A		28	40	mΩ
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =5.0V , I <sub>D</sub> =11A		38	50	
$V_{GS(th)}$	Gate Threshold Voltage	-V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.0	2.0	3.0	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>GS</sub> -V <sub>DS</sub> , I <sub>D</sub> -250uA		-5.68		mV/℃
	Drain Source Lookage Current	$V_{DS}$ =48V , $V_{GS}$ =0V , $T_J$ =25 $^{\circ}$ C	os=48V , V <sub>GS</sub> =0V , T <sub>J</sub> =25℃		1	uA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =48V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =15A		33		S
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7	3.4	Ω
Qg	Total Gate Charge (4.5V)			12	36	
$Q_{gs}$	Gate-Source Charge	$V_{DS}$ =30V , $V_{GS}$ =10V , $I_{D}$ =12A		3.0	5.2	nC
$Q_{gd}$	Gate-Drain Charge			3.2	4.5	
T <sub>d(on)</sub>	Turn-On Delay Time			8.9	16	
T <sub>r</sub>	Rise Time	VDD=30V, RL=30Ω , IDS=1A,		8	15	
T <sub>d(off)</sub>	Turn-Off Delay Time	VGEN=10V, RG=6Ω		28	51	ns
T <sub>f</sub>	Fall Time			22	41	
Ciss	Input Capacitance			830	1000	
C <sub>oss</sub>	Output Capacitance	VGS=0V, VDS=30V, Frequency=1.0MHz		85		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			64		

## **Diode Characteristics**

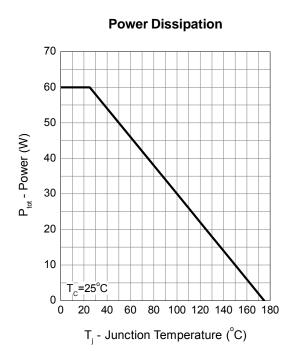
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I <sub>S</sub>	Continuous Source Current <sup>1,6</sup>	V =V =0V Force Current			12	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			70	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	$V_{GS}$ =0V , $I_{S}$ =12A , $T_{J}$ =25 $^{\circ}$ C			1.3	V
t <sub>rr</sub>	Reverse Recovery Time	IE 44 41/44 4004/ TI 05°C		30		nS
Q <sub>rr</sub>	Reverse Recovery Charge	IF=1A ,dl/dt=100A/µs,TJ=25℃		35		nC

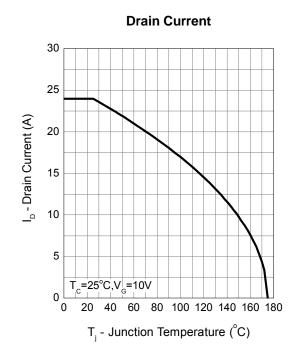
Note a : Pulse test ; pulse width $\leq 300 \, \mu s$ , duty cycle $\leq 2\%$ .

Note b: Guaranteed by design, not subject to production testing.

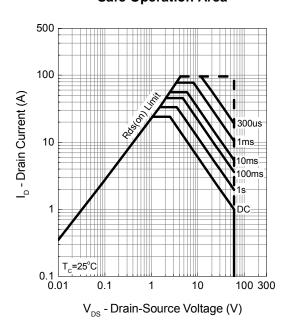


# **Typical Operating Characteristics**

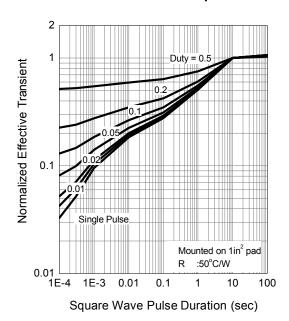




## **Safe Operation Area**

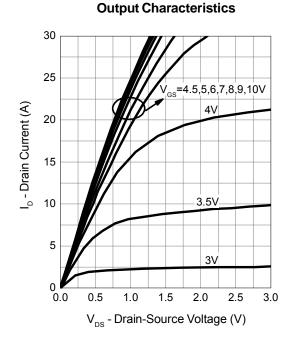


### **Thermal Transient Impedance**

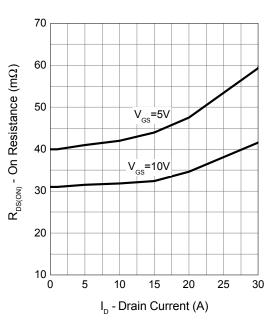




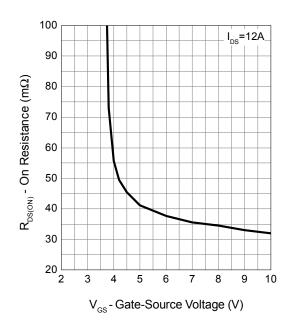
# **Typical Operating Characteristics (Cont.)**



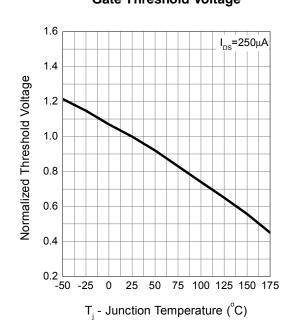
### **Drain-Source On Resistance**



### **Gate-Source On Resistance**



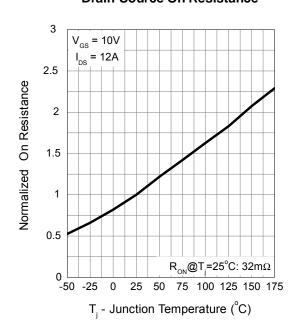
## **Gate Threshold Voltage**



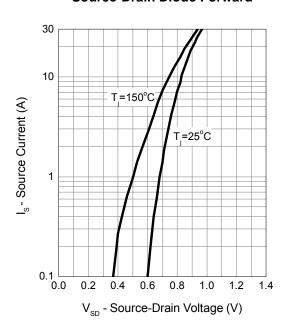


# **Typical Operating Characteristics (Cont.)**

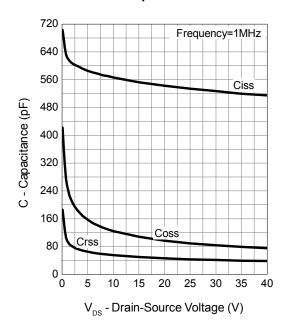
### **Drain-Source On Resistance**



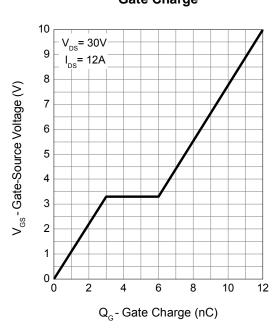
### Source-Drain Diode Forward



### Capacitance

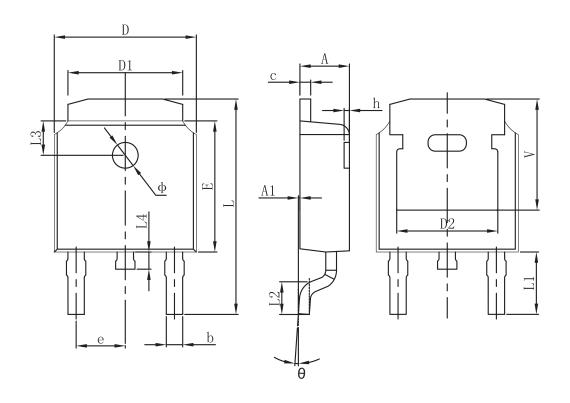


## Gate Charge





## **Packaging information**



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.635	0.770	0.025	0.030	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	REF.	0.190	REF.	
Е	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.712	10.312	0.382	0.406	
L1	2.900 REF.		0.114 REF.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 REF.		0.063 REF.		
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.250	REF.	0.207 REF.		



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